

AN-1437 Current Limit Foldback Improves Short Circuit Protection in LM274X Family

ABSTRACT

This application report discusses the function of the low side current limit used in the LM274X, and presents a simple method to enhance the short-circuit protection, the current limit is required to protect the power components from thermal stress, which can reduce life span. Typically, high side current limit designs require an internal rising edge blanking time or external filter to avoid noise from falsely triggering the current limit comparator. The blanking time delays the current limit comparator from sensing the inductor current. This blanking time plus preventive shoot through dead time (designed into synchronous rectifier devices) determines the minimum on-time for switching regulators. In applications requiring DC-DC conversions from high input voltages to low output voltages, the buck converter must be able to operate down to very short on-time durations.

Contents

1	Introduction	
2	Low Side Current Limit	
3	Output Short Circuit	. 2
4	Enhanced Short-Circuit Protection	. 4
5	Design Procedure	. 4
6	Conclusion	. 5
	List of Figures	
1	Current Limit Threshold	2
2	Error Amplifier and Current Limit Block Diagram	3
3	Low Impedance Short	3
4	Location of the Current Limit Foldback Resistor	4
5	Low Impedance Short	5



Introduction www.ti.com

1 Introduction

For space constrained applications, the typical switching frequency is in the order of 600 kHz to 3 MHz. These switching frequencies are selected to reduce the size of the storage charge elements (the inductor and capacitors). For example, an input voltage of 12 V and an output voltage of 1.2 V will require a buck duty cycle of 10%. Now, if the switching frequency is 1 MHz, the required on-time is 100 ns. Thus, the application requires a current limit design that will allow for narrow on-time pulse to process the required output voltage.

2 Low Side Current Limit

The LM274X employs low side current limit that is implemented by sensing the voltage across the low side MOSFET while it is on, and allows for narrow duty cycle operation. Unlike a high-side MOSFET current sensing design, which limits the peaks of the inductor current, low side current sensing only limits the current during the converter off-time when inductor current is falling. Therefore in a typical current limit plot the valleys are normally well defined, but the peaks are variable according to the duty cycle. During current limit mode the peak inductor current can exceed the current limit threshold, as shown in Figure 1.

When the inductor current exceeds the current limit threshold, the high side MOSFET on-pulse is skipped until the inductor current falls below the current limit threshold, and then it resumes normal on-time pulses.

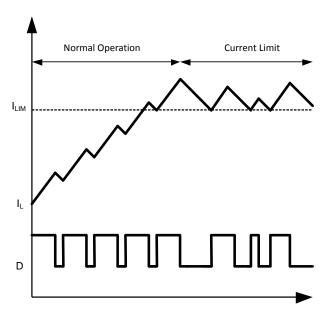


Figure 1. Current Limit Threshold

3 Output Short Circuit

In a typical output short circuit to ground event, the input differential across the error amplifier (EA) will try to force maximum duty cycle pulses. This response increases the average inductor current every cycle until the inductor current exceeds the current limit threshold. In order to minimize the time period in which peak inductor current exceeds the current limit threshold, the LM274X discharges the soft-start (SS) capacitor. Once the SS pin voltage (V_{SS}) is lower than the reference voltage (V_{REF}), V_{SS} will take control of the non-inverting input of the EA and will reduce the duty cycle during this condition. For a simplified block diagram, see Figure 2.



www.ti.com Output Short Circuit

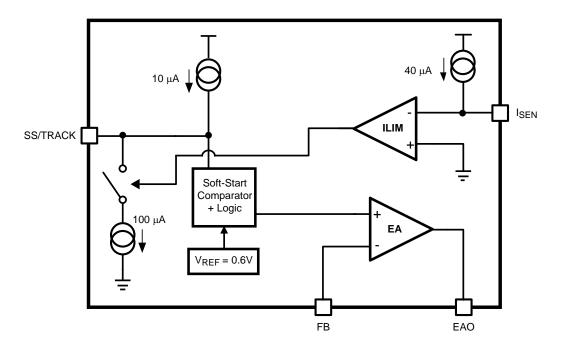


Figure 2. Error Amplifier and Current Limit Block Diagram

By definition a short circuit is a low impedance path established between two points in a circuit. Peak currents are higher with low impedance than with a high impedance output short circuit to ground, because the condition of $V_{SS} > V_{FB}$ can occur. This means that the LM274X may still switch at maximum duty cycle. The worst case short circuit peak current can be approximated by the following equation:

$$I_{PKC} = I_{LIM} + (T_S \times D_{MAX}) \times \frac{V_{IN} - V_{OUT}}{L_O}$$
(1)

where $D_{MAX} = 73\%$ at 300 kHz at 25°C.

Now for an example calculation: $V_{IN} = 12 \text{ V}$, $V_{OUT} = 0 \text{ V}$, $L_O = .68 \mu\text{H}$, and $I_{LIM} = 15 \text{A}$. The peak inductor current (I_{PKC}) results in 57A. The measurement results shown in Figure 3 matches with the calculated values above. If the inductor saturates, the peak inductor current will increase. The following section explains how to reduce the peak current during low impedance short circuit events.

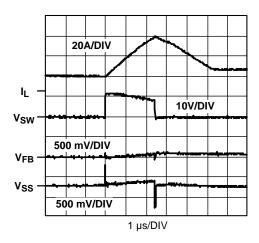


Figure 3. Low Impedance Short



4 Enhanced Short-Circuit Protection

To enhance the short circuit protection, connecting a single resistor (R_{CLF}) from I_{SEN} to V_{OUT} , as shown in Figure 4, decreases the DC current limit level during a short circuit from output to ground. Section 5 provides selection guidelines for the foldback current limit (P_{LIM}), R_{CLF} , and the current limit resistor (R4).

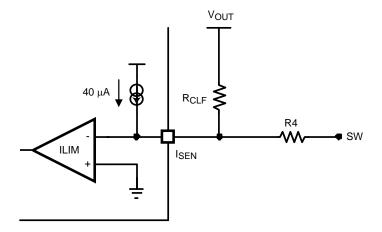


Figure 4. Location of the Current Limit Foldback Resistor

5 Design Procedure

Given the following application parameters: V_{IN} , V_{OUT} , bottom FET $R_{DS(ON)}$, I_{LIM} . Select the percentage of current limit foldback (P_{LIM}):

$$P_{IM} = I_{IM} \times P \tag{2}$$

where, P is a ratio between 0 and 1.

Obtain R4 as shown in Equation 3:

$$R4 = \frac{P_{LIM} x R_{DS(ON)}}{I_{SEN}}$$
(3)

where, $I_{SEN} = 40 \mu A$ (typ).

If the input voltage goes above 9.5 V, the following criterion must be satisfied.

$$R4 \ge \frac{V_{\text{IN}} - 9.5V}{10 \text{ mA}} \tag{4}$$

For example, V_{INmax} = 13.2 V, the minimum R4 value is 370 Ω .

The equation for calculating R_{CLF} value is shown in Equation 5:

$$R_{CLF} = \frac{R4 \times V_{OUT}}{\left(I_{LIM} \times R_{DS(ON)}\right) - \left(I_{SEN} \times R4\right)}$$
(5)

Use the hot R_{DS(ON)} value found in the manufacturer's data sheet.

With new resistance value for R4 and the introduction of R_{CLF} , you can verify the reduction in peak current during an output short circuit to ground. Thus, assuming the inductor does not saturate, use Equation 6 to calculate peak current during an output short circuit to ground.

$$I_{PKC} = P_{LIM} + (T_S \times D_{MAX}) \times \frac{V_{IN} - V_{OUT}}{L_O}$$
 (6)



www.ti.com Conclusion

Under the same condition as the first calculated example: $D_{MAX} = 73\%$ at 300 kHz at 25°C, $V_{IN} = 12$ V, $V_{OUT} = 0$ V, $L_O = .68$ μ H, and $P_{LIM} = 5$ A. I_{PKC} results in 47A. Figure 5 shows the measured inductor current, which matches with the calculated value above. In this case, you have reduced the peak inductor current by 10A.

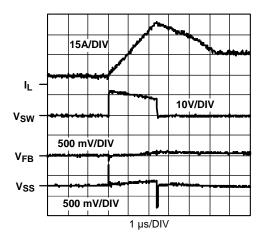


Figure 5. Low Impedance Short

6 Conclusion

In summary, the LM274X family can provide narrow duty cycle operation. By introducing a single resistor, the peak currents can be reduced when the output of the regulator is short circuit to ground.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID www.ti-rfid.com

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>